

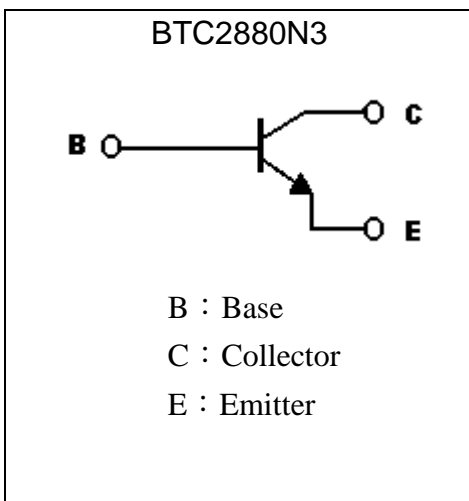
General Purpose NPN Epitaxial Planar Transistor

BTC2880N3

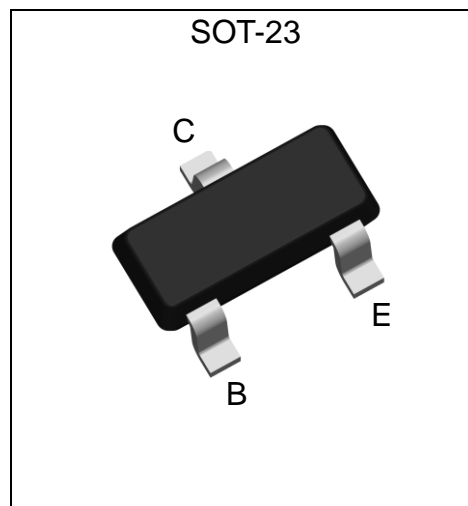
Features

- High breakdown voltage, $BV_{CEO} \geq 100V$
- Large continuous collector current capability
- Low collector saturation voltage
- Pb-free lead plating and halogen-free package

Symbol

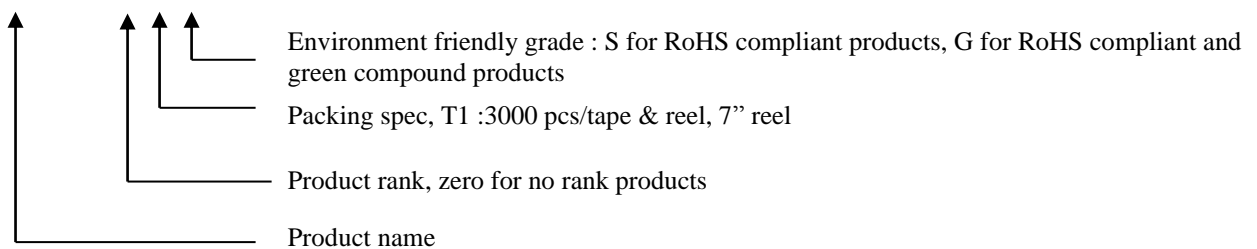


Outline



Ordering Information

Device	Package	Shipping
BTC2880N3-0-T1-G	SOT-23 (Pb-free lead plating and halogen-free package)	3000 pcs / Tape & Reel



**Absolute Maximum Ratings** (Ta=25°C)

Parameter	Symbol	Limits	Unit
Collector-Base Voltage	V _{CBO}	180	V
Collector-Emitter Voltage	V _{CEO}	100	V
Emitter-Base Voltage	V _{EBO}	7	V
Collector Current	I _C	2	A
Peak Collector Current	I _{CM}	5	A
Base Current	I _B	0.4	A
Power Dissipation	P _D	225	mW
Thermal Resistance, Junction to Ambient	R _{θJA}	556	°C/W
Operating Junction and Storage Temperature Range	T _j ; T _{stg}	-55~+150	°C

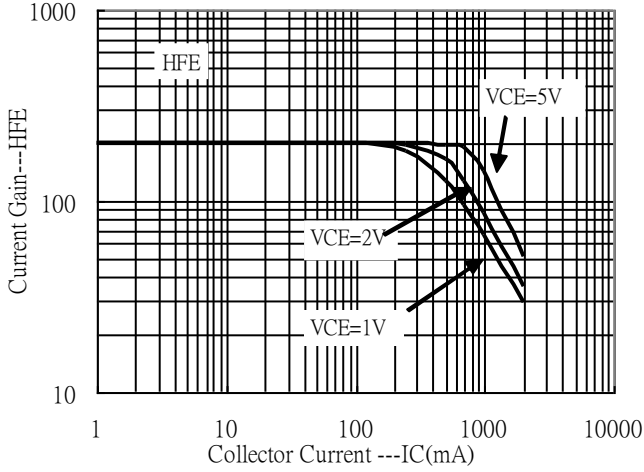
Characteristics (Ta=25°C)

Symbol	Min.	Typ.	Max.	Unit	Test Conditions
BV _{CBO}	180	-	-	V	I _C =50μA
BV _{CEO}	100	-	-	V	I _C =1mA
BV _{EBO}	7	-	-	V	I _E =50μA
I _{CBO}	-	-	100	nA	V _{CB} =180V
I _{EBO}	-	-	100	nA	V _{EB} =6V
*V _{CE(sat)}	-	0.11	0.2	V	I _C =500mA, I _B =50mA
*V _{CE(sat)}	-	0.22	0.4	V	I _C =1A, I _B =50mA
*V _{CE(sat)}	-	0.44	1	V	I _C =2A, I _B =100mA
*V _{BE(sat)}	-	0.85	1.2	V	I _C =500mA, I _B =50mA
*V _{BE(on)}	-	0.77	0.9	V	V _{CE} =5V, I _C =500mA
*h _{FE} 1	120	-	-	-	V _{CE} =5V, I _C =50mA
*h _{FE} 2	150	-	250	-	V _{CE} =5V, I _C =100mA
*h _{FE} 3	80	-	-	-	V _{CE} =5V, I _C =1A
f _T	50	-	-	MHz	V _{CE} =10V, I _C =50mA, f=100MHz
C _{ob}	-	18	40	pF	V _{CB} =10V, I _E =0A, f=1MHz

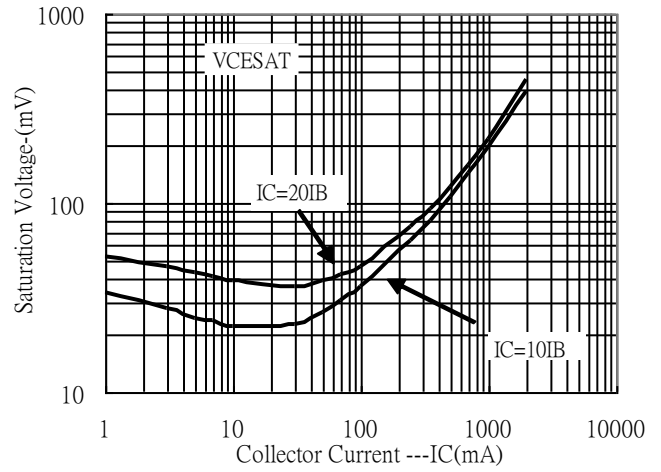
*Pulse Test: Pulse Width ≤380μs, Duty Cycle≤2%

Typical Characteristics

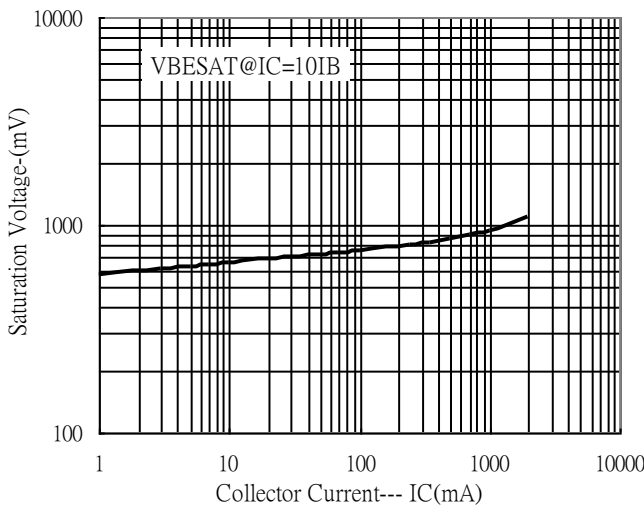
Current Gain vs Collector Current



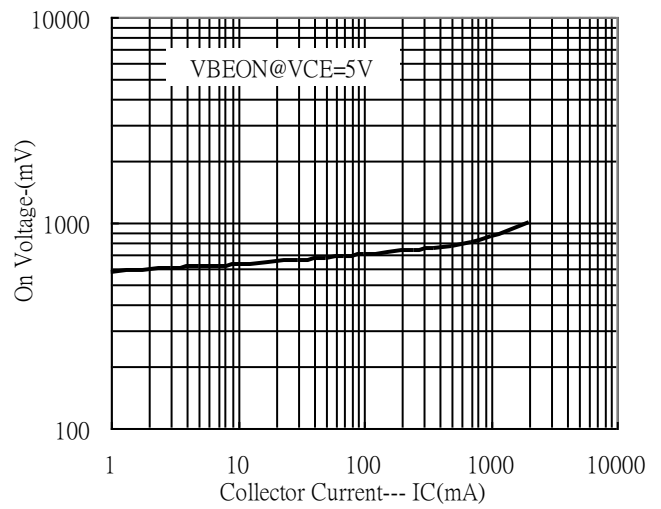
Saturation Voltage vs Collector Current



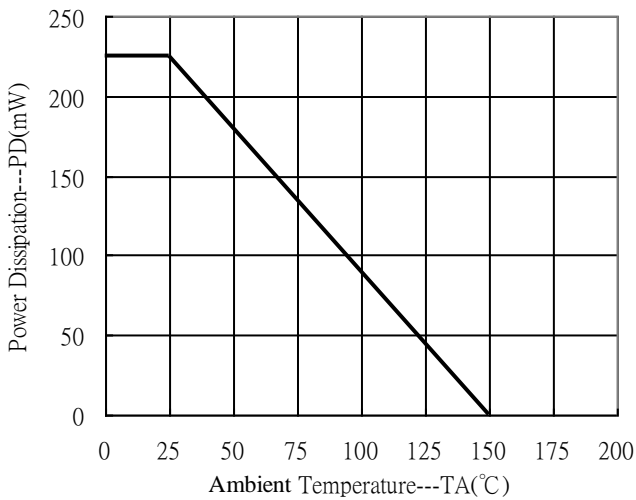
Saturation Voltage vs Collector Current



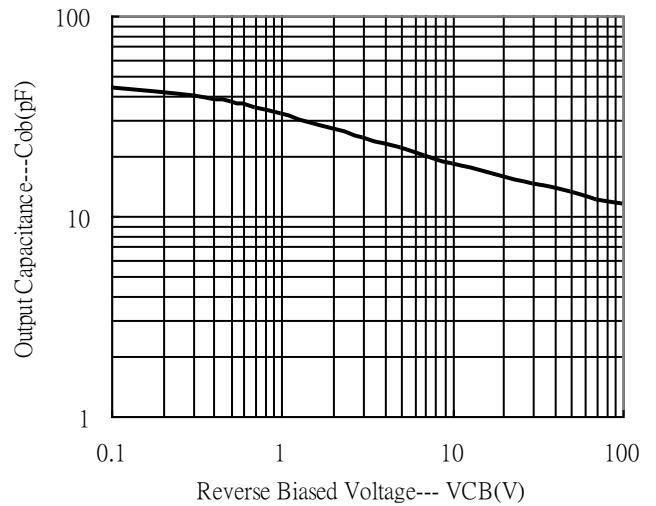
On Voltage vs Collector Current



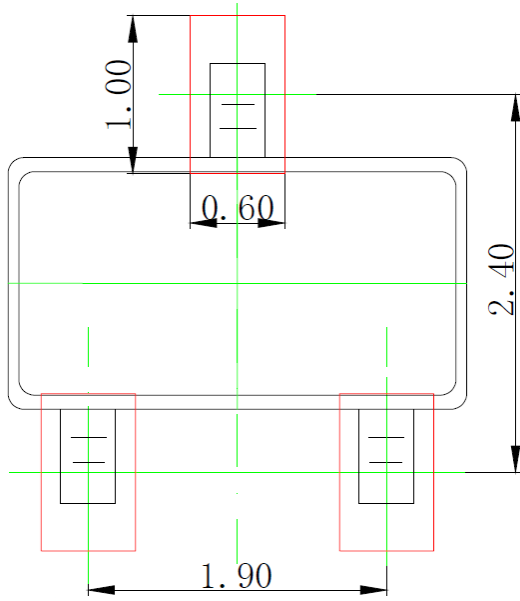
Power Derating Curve



Output Capacitance vs Reverse Biased Voltage

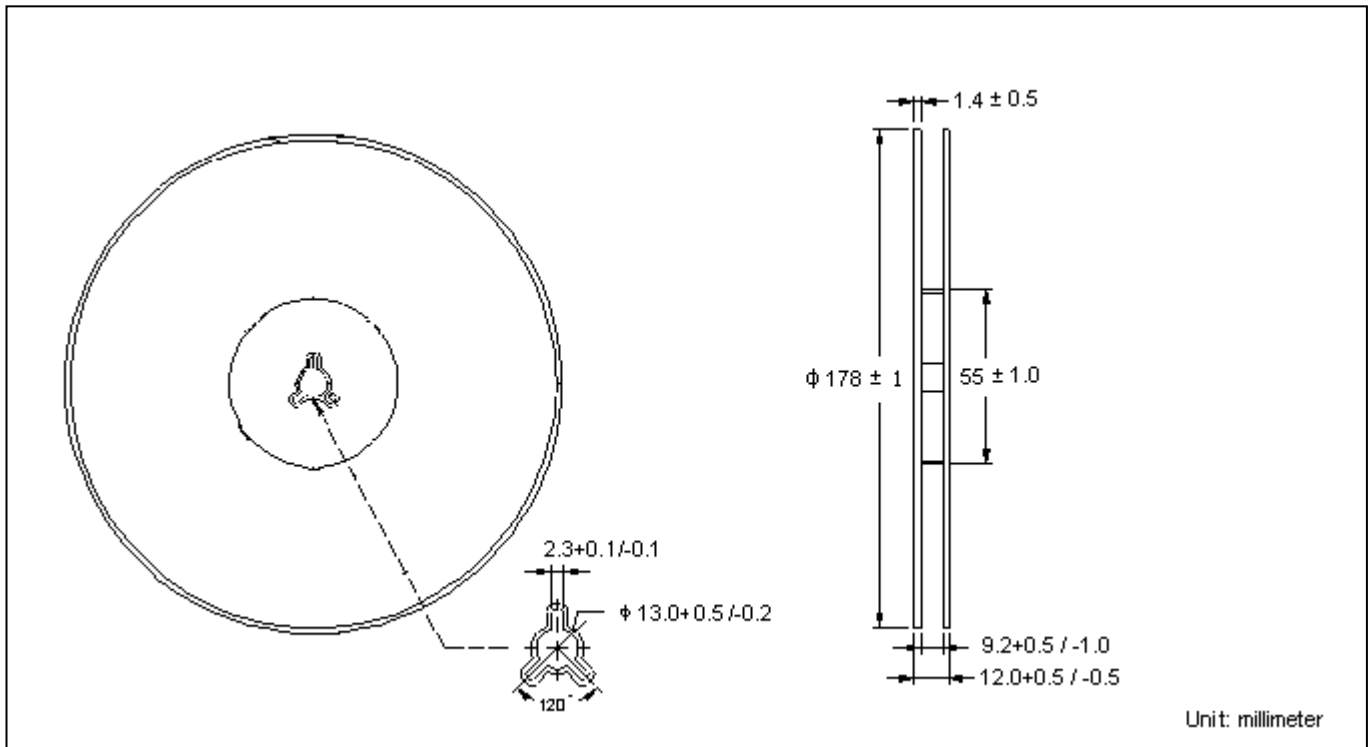


Recommended Soldering Footprint

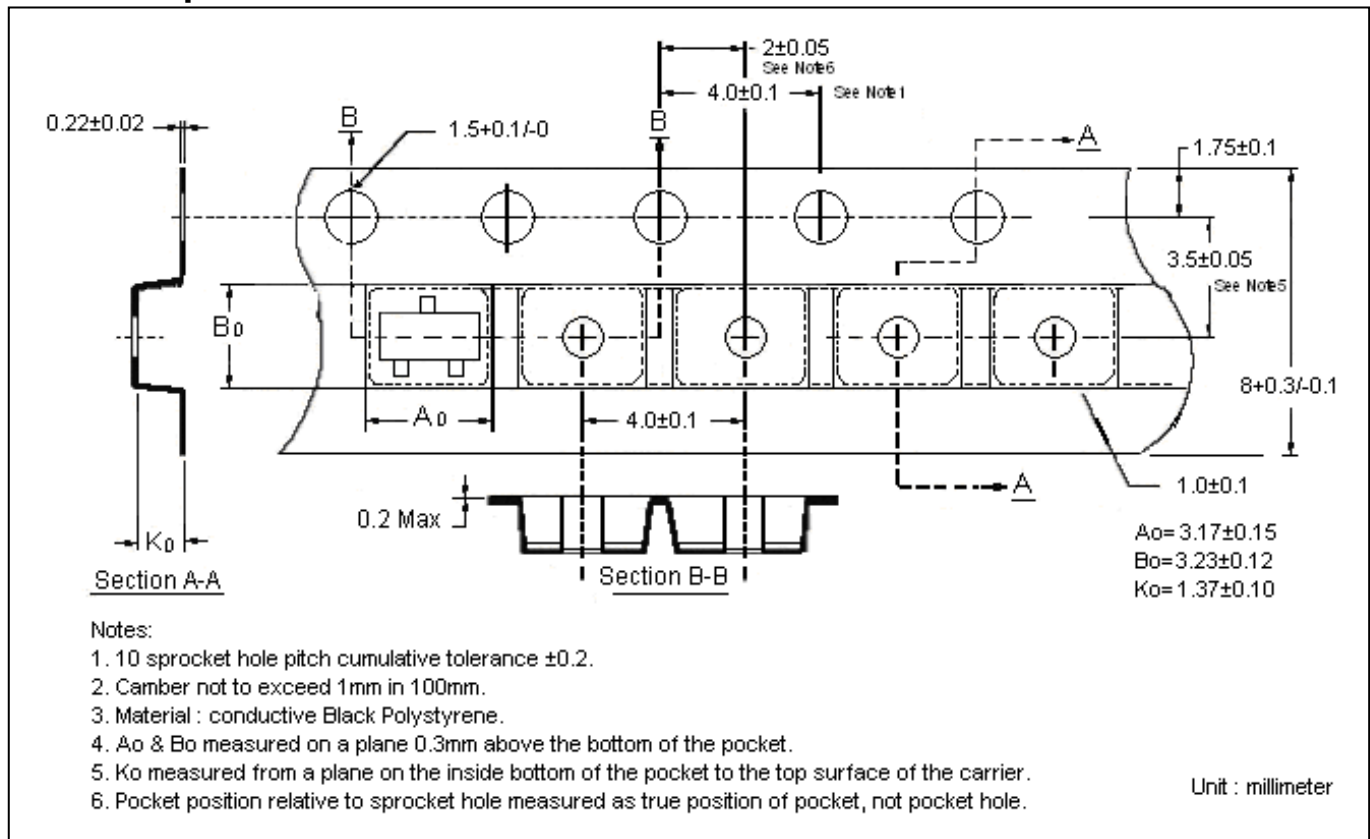


Unit:mm

Reel Dimension



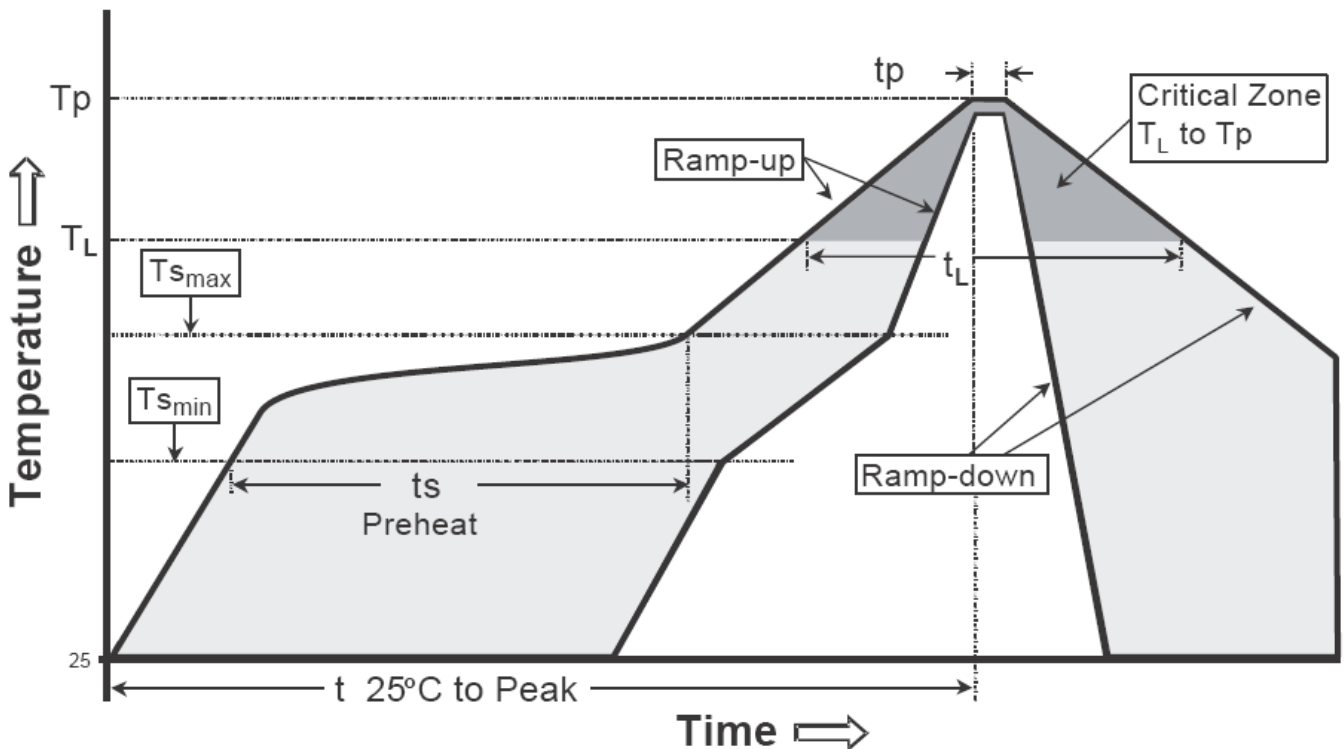
Carrier Tape Dimension



Recommended wave soldering condition

Product	Peak Temperature	Soldering Time
Pb-free devices	260 +0/-5 °C	5 +1/-1 seconds

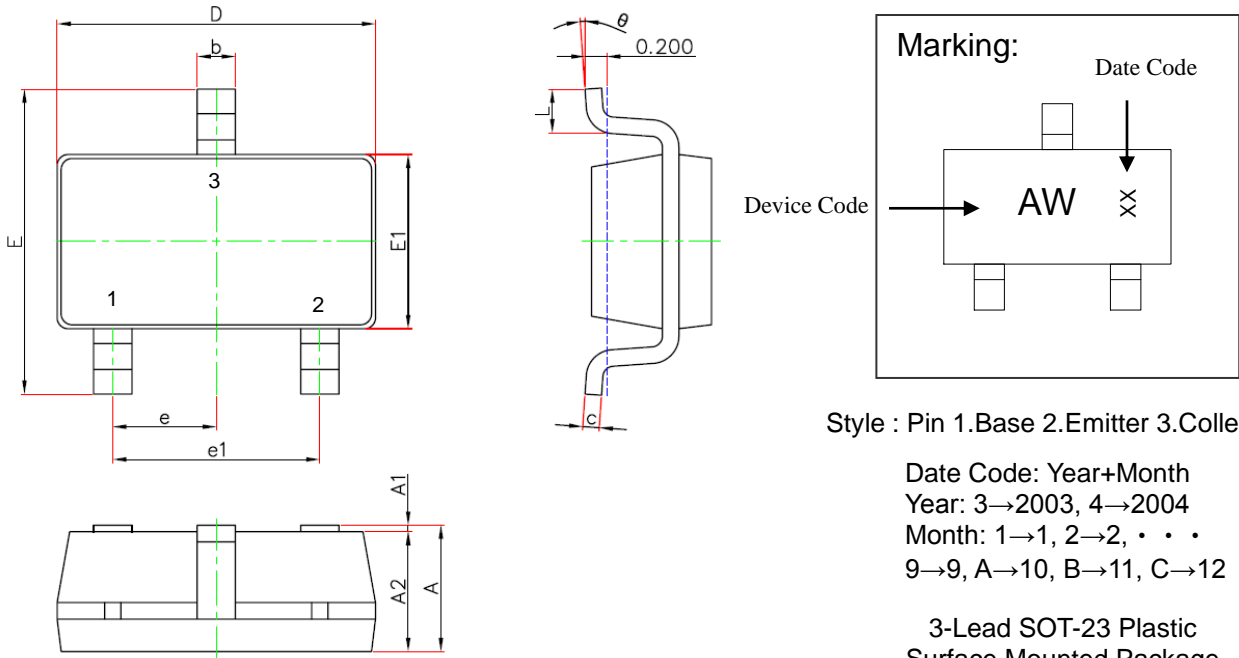
Recommended temperature profile for IR reflow



Profile feature	Sn-Pb eutectic Assembly	Pb-free Assembly
Average ramp-up rate (Tsmax to Tp)	3°C/second max.	3°C/second max.
Preheat		
-Temperature Min(Ts min)	100°C	150°C
-Temperature Max(Ts max)	150°C	200°C
-Time(ts min to ts max)	60-120 seconds	60-180 seconds
Time maintained above:		
-Temperature (TL)	183°C	217°C
- Time (tL)	60-150 seconds	60-150 seconds
Peak Temperature(Tp)	240 +0/-5 °C	260 +0/-5 °C
Time within 5°C of actual peak temperature(tp)	10-30 seconds	20-40 seconds
Ramp down rate	6°C/second max.	6°C/second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

Note : All temperatures refer to topside of the package, measured on the package body surface.

SOT-23 Dimension



Marking: Date Code
 Device Code → AW x x

Style : Pin 1.Base 2.Emitter 3.Collector

Date Code: Year+Month
 Year: 3→2003, 4→2004
 Month: 1→1, 2→2, . . .
 9→9, A→10, B→11, C→12

3-Lead SOT-23 Plastic
 Surface Mounted Package
 CYStek Package Code: N3

DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	0.041	0.049	1.05	1.25	E1	0.059	0.067	1.50	1.70
A1	0.000	0.004	0.00	0.10	E	0.104	0.116	2.65	2.95
A2	0.041	0.045	1.05	1.15	e	0.037 BSC		0.95 BSC	
b	0.012	0.020	0.30	0.50	e1	0.071	0.079	1.80	2.00
c	0.004	0.008	0.10	0.20	L	0.012	0.024	0.30	0.60
D	0.111	0.119	2.82	3.02	θ	0°	8°	0°	8°

Notes: 1.Controlling dimension: millimeters.
 2.Maximum lead thickness includes lead finish thickness, and minimum lead thickness is the minimum thickness of base material.
 3.If there is any question with packing specification or packing method, please contact your local CYStek sales office.

Material:

- Lead: Pure tin plated.
- Mold Compound: Epoxy resin family, flammability solid burning class: UL94V-0.

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